

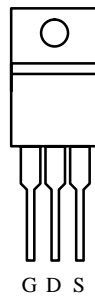
N-Channel Enhancement-Mode Transistors

Product Summary

$V_{(BR)DSS}$ (V)	$r_{DS(on)}$ (Ω)	I_D (A)
60	0.018	60

175°C Rated
Maximum Junction Temperature

TO-220AB



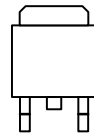
G D S

Top View

SUP60N06-18

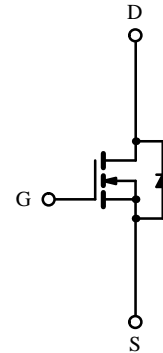
DRAIN connected to TAB

TO-263



G D S
Top View

SUB60N06-18



N-Channel MOSFET

Absolute Maximum Ratings ($T_C = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	Limit	Unit
Drain-Source Voltage	V_{DS}	60	V
Gate-Source Voltage	V_{GS}	± 20	
Continuous Drain Current ($T_J = 175^\circ\text{C}$)	I_D	$T_C = 25^\circ\text{C}$	60
		$T_C = 100^\circ\text{C}$	39
Pulsed Drain Current	I_{DM}	120	A
Avalanche Current	I_{AR}	60	
Repetitive Avalanche Energy ^a	E_{AR}	180	mJ
Power Dissipation	P_D	$T_C = 25^\circ\text{C}$ (TO-220AB and TO-263)	120 ^b
		$T_A = 25^\circ\text{C}$ (TO-263) ^c	3.7
Operating Junction and Storage Temperature Range	T_J, T_{stg}	-55 to 175	$^\circ\text{C}$

Thermal Resistance Ratings

Parameter	Symbol	Limit	Unit
Junction-to-Ambient	R_{thJA}	PCB Mount (TO-263) ^c	40
		Free Air (TO-220AB)	62.5
Junction-to-Case	R_{thJC}	1.25	$^\circ\text{C}/\text{W}$

Notes:

- Duty cycle $\leq 1\%$.
- See SOA curve for voltage derating.
- When mounted on 1" square PCB (FR-4 material).

Updates to this data sheet may be obtained via facsimile by calling Siliconix FaxBack, 1-408-970-5600. Please request FaxBack document #70290. A SPICE Model data sheet is available for this product (FaxBack document #70540).

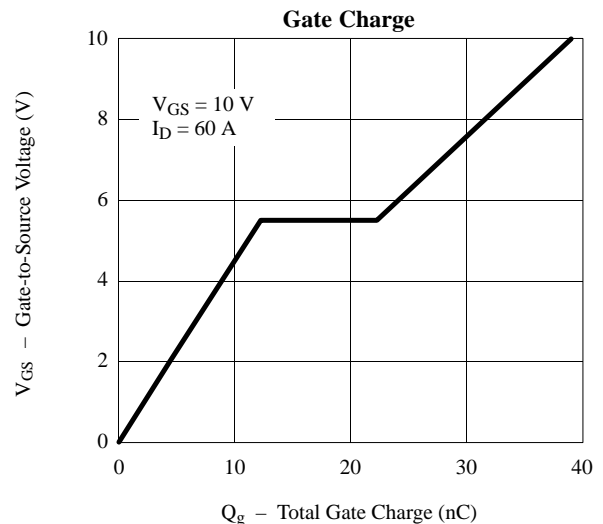
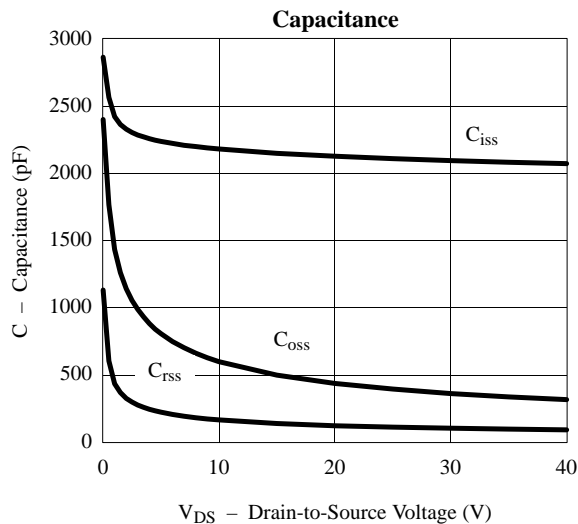
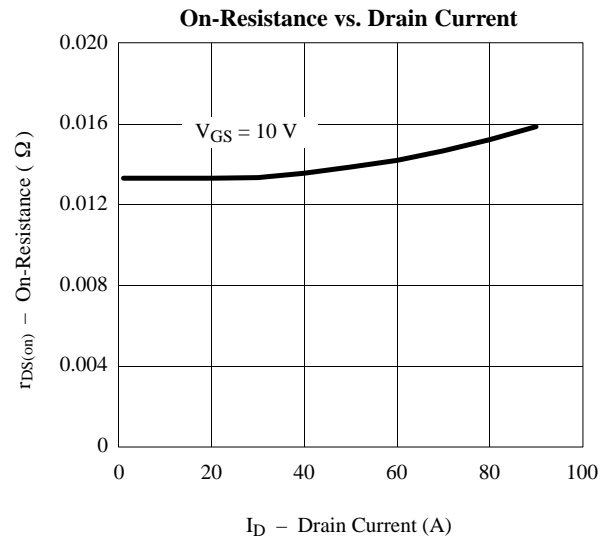
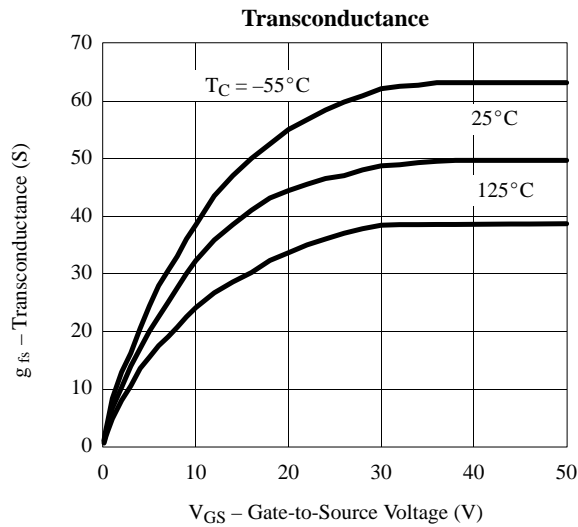
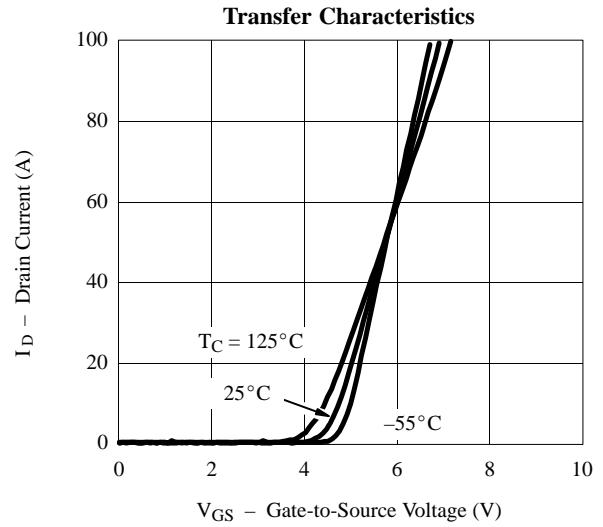
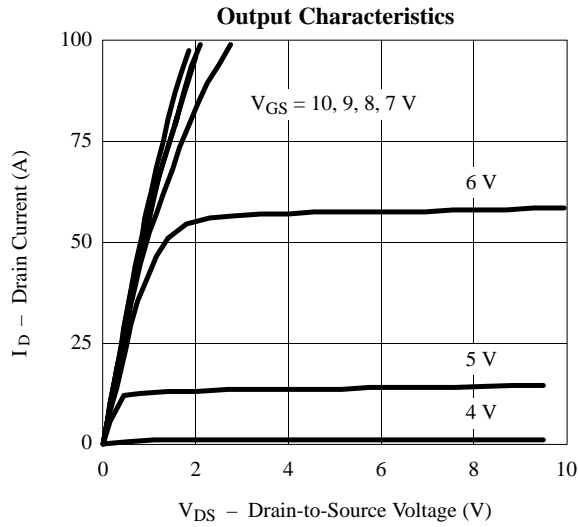
Specifications ($T_J = 25^\circ\text{C}$ Unless Otherwise Noted)

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Static						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0\text{ V}, I_D = 250\ \mu\text{A}$	60			V
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_{DS} = 1\ \text{mA}$	2.0		4.0	
Gate-Body Leakage	I_{GSS}	$V_{DS} = 0\ \text{V}, V_{GS} = \pm 20\ \text{V}$			± 100	nA
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 60\ \text{V}, V_{GS} = 0\ \text{V}$			1	μA
		$V_{DS} = 60\ \text{V}, V_{GS} = 0\ \text{V}, T_J = 125^\circ\text{C}$			50	
		$V_{DS} = 60\ \text{V}, V_{GS} = 0\ \text{V}, T_J = 175^\circ\text{C}$			150	
On-State Drain Current ^b	$I_{D(on)}$	$V_{DS} = 5\ \text{V}, V_{GS} = 10\ \text{V}$	60			A
Drain-Source On-State Resistance ^b	$r_{DS(on)}$	$V_{GS} = 10\ \text{V}, I_D = 30\ \text{A}$		0.014	0.018	Ω
		$V_{GS} = 10\ \text{V}, I_D = 30\ \text{A}, T_J = 125^\circ\text{C}$		0.024	0.030	
		$V_{GS} = 10\ \text{V}, I_D = 30\ \text{A}, T_J = 175^\circ\text{C}$		0.031	0.036	
Forward Transconductance ^b	g_{fs}	$V_{DS} = 15\ \text{V}, I_D = 30\ \text{A}$		49		S
Dynamic^a						
Input Capacitance	C_{iss}	$V_{GS} = 0\ \text{V}, V_{DS} = 25\ \text{V}, f = 1\ \text{MHz}$		2000		pF
Output Capacitance	C_{oss}			400		
Reverse Transfer Capacitance	C_{rss}			115		
Total Gate Charge ^c	Q_g	$V_{DS} = 30\ \text{V}, V_{GS} = 10\ \text{V}, I_D = 60\ \text{A}$		39	60	nC
Gate-Source Charge ^c	Q_{gs}			12		
Gate-Drain Charge ^c	Q_{gd}			10		
Turn-On Delay Time ^c	$t_{d(on)}$	$V_{DD} = 30\ \text{V}, R_L = 0.5\ \Omega$ $I_D \approx 60\ \text{A}, V_{GEN} = 10\ \text{V}, R_G = 2.5\ \Omega$		12	30	ns
Rise Time ^c	t_r			11	30	
Turn-Off Delay Time ^c	$t_{d(off)}$			25	50	
Fall Time ^c	t_f			15	30	
Source-Drain Diode Ratings and Characteristics ($T_C = 25^\circ\text{C}$)^a						
Continuous Current	I_s				60	A
Pulsed Current	I_{SM}				120	
Forward Voltage ^b	V_{SD}	$I_F = 60\ \text{A}, V_{GS} = 0\ \text{V}$			1.6	V
Reverse Recovery Time	t_{rr}	$I_F = 60\ \text{A}, di/dt = 100\ \text{A}/\mu\text{s}$		60		ns
Peak Reverse Recovery Current	$I_{RM(REC)}$			6.0		A
Reverse Recovery Charge	Q_{rr}			0.4		μC

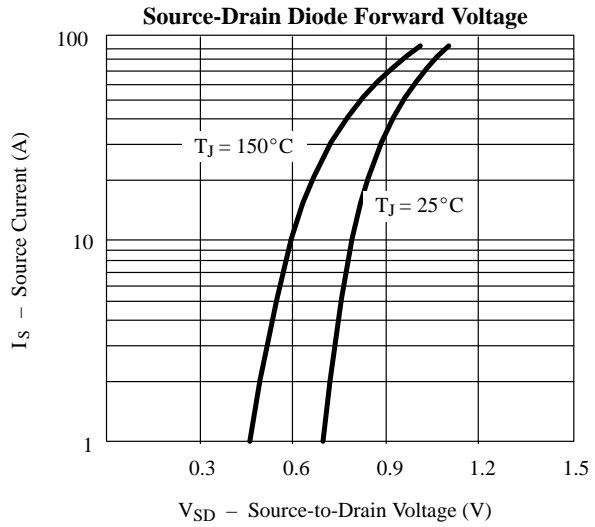
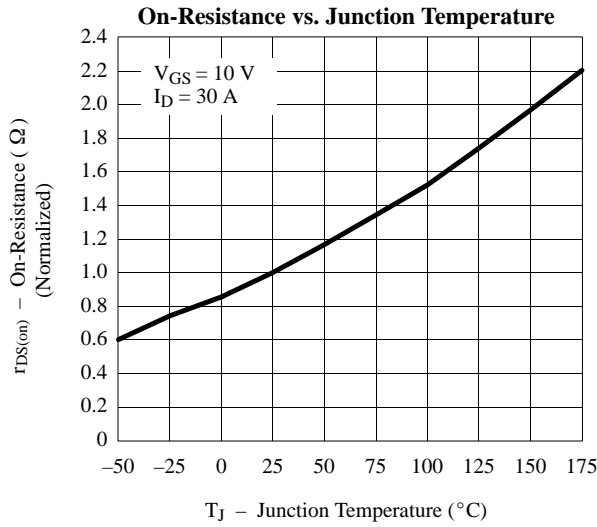
Notes:

- Guaranteed by design, not subject to production testing.
- Pulse test; pulse width $\leq 300\ \mu\text{s}$, duty cycle $\leq 2\%$.
- Independent of operating temperature.

Typical Characteristics (25°C Unless Otherwise Noted)



Typical Characteristics (25°C Unless Otherwise Noted)



Thermal Ratings

